

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Yuhei Sato</td> <td>03/29/2012</td> </tr> <tr> <td>Keiji Sato</td> <td>03/29/2012</td> </tr> <tr> <td>Toshinari Sasaki</td> <td>03/20/2012</td> </tr> <tr> <td>Tetsunori Maruyama</td> <td>03/29/2012</td> </tr> <tr> <td>Atsuo Isobe</td> <td>03/29/2012</td> </tr> <tr> <td>Tsutomu Murakawa</td> <td>03/29/2012</td> </tr> <tr> <td>Sachiaki Tezuka</td> <td>03/29/2012</td> </tr> </tbody> </table>		Name	Execution Date	Yuhei Sato	03/29/2012	Keiji Sato	03/29/2012	Toshinari Sasaki	03/20/2012	Tetsunori Maruyama	03/29/2012	Atsuo Isobe	03/29/2012	Tsutomu Murakawa	03/29/2012	Sachiaki Tezuka	03/29/2012
Name	Execution Date																
Yuhei Sato	03/29/2012																
Keiji Sato	03/29/2012																
Toshinari Sasaki	03/20/2012																
Tetsunori Maruyama	03/29/2012																
Atsuo Isobe	03/29/2012																
Tsutomu Murakawa	03/29/2012																
Sachiaki Tezuka	03/29/2012																
RECEIVING PARTY DATA																	
Name:	Semiconductor Energy Laboratory Co., Ltd.																
Street Address:	398, Hase																
City:	Atsugi-shi, Kanagawa-ken																
State/Country:	JAPAN																
Postal Code:	243-0036																
PROPERTY NUMBERS Total: 1																	
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13437271</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13437271												
Property Type	Number																
Application Number:	13437271																
CORRESPONDENCE DATA																	
Fax Number:	(703)766-2394																
Phone:	(571) 434-6789																
Email:	uspto@riplo.com																
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>																	
Correspondent Name:	Eric J. Robinson																
Address Line 1:	Robinson IP Law Office, P.C.																
Address Line 2:	3975 Fair Ridge Drive, Suite 20 North																
Address Line 4:	Fairfax, VIRGINIA 22033																

OP \$40.00 13437271

ATTORNEY DOCKET NUMBER:	0756-9714
NAME OF SUBMITTER:	Eric J. Robinson
Total Attachments: 3 source=assignment#page1.tif source=assignment#page2.tif source=assignment#page3.tif	

ASSIGNMENT

Serial No. _____

Filed _____

WHEREAS, Yuhei SATO, Keiji SATO, Toshinari SASAKI, Tetsunori MARUYAMA, Atsuo ISOBE, Tsutomu MURAKAWA and Sachiaki TEZUKA

(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in MANUFACTURING METHOD OF SEMICONDUCTOR DEVICE for which an application for Letters Patent of the United States of America has been executed by the undersigned on _____, and;

WHEREAS, Semiconductor Energy Laboratory Co., Ltd. of 398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan and its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America and its territories and for all foreign countries, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America and its territories, dependencies and possessions, and in and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or any continuation, division or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims under or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from

said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of ROBINSON INTELLECTUAL PROPERTY LAW OFFICE the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

In witness thereof, this Assignment has been executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 03/29/2012 Signature Yuhei Sato
Name Yuhei SATO

Date 03/29/2012 Signature Keiji Sato
Name Keiji SATO

Date 03/20/2012 Signature Toshinari Sasaki
Name Toshinari SASAKI

Date 03/29/2012 Signature Tetsunori MARUYAMA
Name Tetsunori MARUYAMA

Date 03/29/2012 Signature Atsuo Irobe
Name Atsuo ISOBE

Date 03/29/2012 Signature Tsutomu murakawa
Name Tsutomu MURAKAWA

Date 03/29/2012 Signature Sachiaki Tezuka
Name Sachiaki TEZUKA

This assignment should preferably be acknowledged before a United States Consul or Notary Public. If not, then the execution by the Inventor(s) should be witnessed has (have)

invented certain new and useful improvements in by at least two other persons who should sign here.

Witness _____

Signature _____

Witness _____

Signature _____

Witness _____

Signature _____